

## SFH7050



### Features:

- Multi chip package featuring 3 emitters and one detector
- Small package:  
(WxDxH) 4.7 mm x 2.5 mm x 0.9 mm
- Light Barrier to block optical crosstalk

### Applications

- Heart rate monitoring
- Pulse oximetry

for:

- Wearable devices (e.g. smart watches, fitness trackers, ...)
- Mobile devices

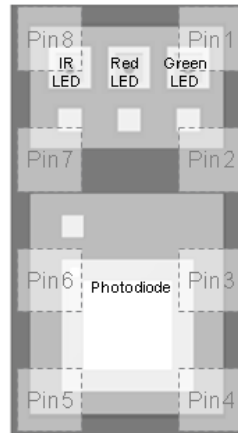
### Ordering Information SFH7050 BioMon

Type:	Ordering Code
SFH7050	Q65111A6271

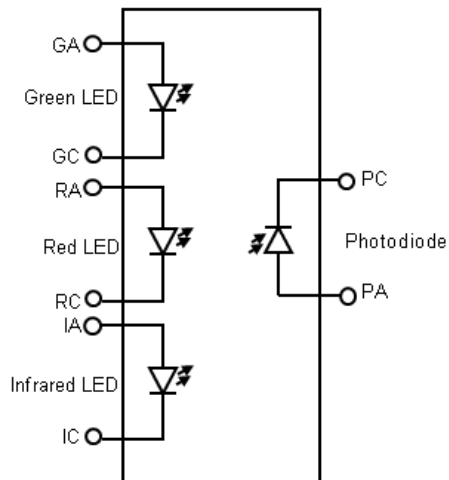
## Pin configuration

Pin	Name	Function
1	GC	Green LED Cathode
2	GA	Green LED Anode
3	RA	Red LED Anode
4	PA	Photodiode Anode
5	PC	Photodiode Cathode
6	RC	Red LED Cathode
7	IA	Infrared LED Anode
8	IC	Infrared LED Cathode

## Top view



## Block diagram



**Maximum Ratings** ( $T_A = 25\text{ °C}$ )

Parameter	Symbol	Values	Unit
<b>General</b>			
Operating temperature range	$T_{op}$	-40 ... 85	°C
Storage temperature range	$T_{stg}$	-40 ... 85	°C
ESD withstand voltage (acc. to ANSI/ ESDA/ JEDEC JS-001 - HBM)	$V_{ESD}$	2	kV
<b>Infrared Emitter</b>			
Reverse Voltage	$V_R$	5	V
Forward current	$I_{F(DC)}$	60	mA
Surge current ( $t_p = 100\ \mu\text{s}$ , $D = 0$ )	$I_{FSM}$	1	A
<b>Red Emitter</b>			
Reverse voltage	$V_R$	12	V
Forward current	$I_{F(DC)}$	40	mA
Surge current ( $t_p = 100\ \mu\text{s}$ , $D = 0$ )	$I_{FSM}$	600	mA
<b>Green Emitter</b>			
Reverse voltage	$V_R$	not designed for reverse operation	V
Forward current	$I_{F(DC)}$	25	mA
Surge current ( $t_p = 100\ \mu\text{s}$ , $D = 0$ )	$I_{FSM}$	300	mA
<b>Detector</b>			
Reverse voltage	$V_R$	16	V

**Note:** The stated maximum ratings refer to single emitter chip operation, unless otherwise specified.

Characteristics ( $T_A = 25\text{ °C}$ )

Parameter		Symbol	Value	Unit
<b>Infrared Emitter</b>				
Wavelength of peak emission ( $I_F = 20\text{ mA}$ , $t_p = 20\text{ ms}$ )	(typ.)	$\lambda_{\text{peak}}$	950	nm
Centroid Wavelength ( $I_F = 20\text{ mA}$ , $t_p = 20\text{ ms}$ )	(typ. (max.))	$\lambda_{\text{centroid}}$	940 ( $\pm 10$ )	nm
Spectral bandwidth at 50% of $I_{\text{max}}$ ( $I_F = 20\text{ mA}$ , $t_p = 20\text{ ms}$ )	(typ.)	$\Delta\lambda$	42	nm
Half angle	(typ.)	$\varphi$	$\pm 60$	$^\circ$
Rise and fall time of $I_e$ (10% and 90% of $I_{e,\text{max}}$ ) ( $I_F = 100\text{ mA}$ , $t_p = 16\text{ }\mu\text{s}$ , $R_L = 50\text{ }\Omega$ )	(typ.)	$t_r$ , $t_f$	16	ns
Forward voltage ( $I_F = 20\text{ mA}$ , $t_p = 20\text{ ms}$ )	(typ. (max.))	$V_F$	1.3 ( $\leq 1.8$ )	V
Reverse current		$I_R$	not designed for reverse operation	$\mu\text{A}$
Radiant intensity ( $I_F = 20\text{ mA}$ , $t_p = 20\text{ ms}$ )	(typ.)	$I_e$	2	mW / sr
Total radiant flux ( $I_F = 20\text{ mA}$ , $t_p = 20\text{ ms}$ )	(typ.)	$\Phi_e$	5.3	mW
Temperature coefficient of $I_e$ or $\Phi_e$ ( $I_F = 20\text{ mA}$ , $t_p = 20\text{ ms}$ )	(typ.)	$TC_I$	-0.3	% / K
Temperature coefficient of $V_F$ ( $I_F = 20\text{ mA}$ , $t_p = 20\text{ ms}$ )	(typ.)	$TC_V$	-0.8	mV / K
Temperature coefficient of $\lambda_{\text{centroid}}$ ( $I_F = 20\text{ mA}$ , $t_p = 20\text{ ms}$ )	(typ.)	$TC_{\lambda_{\text{centroid}}}$	0.25	nm / K

**Characteristics** ( $T_A = 25\text{ °C}$ )

Parameter		Symbol	Value	Unit
<b>Red Emitter</b>				
Wavelength of peak emission ( $I_F = 20\text{ mA}$ )	(typ.)	$\lambda_{\text{peak}}$	660	nm
Centroid Wavelength ( $I_F = 20\text{ mA}$ )	(typ. (max.))	$\lambda_{\text{centroid}}$	655 ( $\pm 3$ )	nm
Spectral bandwidth at 50% of $I_{\text{max}}$ ( $I_F = 20\text{ mA}$ )	(typ.)	$\Delta\lambda$	17	nm
Half angle	(typ.)	$\varphi$	$\pm 60$	$^\circ$
Rise and fall time of $I_e$ (10% and 90% of $I_{e\text{max}}$ ) ( $I_F = 100\text{ mA}$ , $t_p = 16\text{ }\mu\text{s}$ , $R_L = 50\text{ }\Omega$ )	(typ.)	$t_r$ , $t_f$	17	ns
Forward voltage ( $I_F = 20\text{ mA}$ )	(typ. (max.))	$V_F$	2.1 ( $\leq 2.8$ )	V
Reverse current	(typ. (max.))	$I_R$	not designed for reverse operation	$\mu\text{A}$
Radiant intensity ( $I_F = 20\text{ mA}$ , $t_p = 20\text{ ms}$ )	(typ.)	$I_e$	2.6	mW / sr
Total radiant flux ( $I_F = 20\text{ mA}$ , $t_p = 20\text{ ms}$ )	(typ.)	$\Phi_e$	6.4	mW
Temperature coefficient of $\lambda_{\text{centroid}}$ ( $I_F = 20\text{ mA}$ , $-10^\circ\text{C} \leq T \leq 100^\circ\text{C}$ )	(typ.)	$\text{TC}_{\lambda_{\text{centroid}}}$	0.13	nm / K

**Characteristics** ( $T_A = 25\text{ °C}$ )

Parameter		Symbol	Value	Unit
<b>Green Emitter</b>				
Wavelength of peak emission ( $I_F = 20\text{ mA}$ )	(typ.)	$\lambda_{\text{peak}}$	525	nm
Centroid Wavelength ( $I_F = 20\text{ mA}$ )	(typ. (max.))	$\lambda_{\text{centroid}}$	530 ( $\pm 10$ )	nm
Spectral bandwidth at 50% of $I_{\text{max}}$ ( $I_F = 20\text{ mA}$ )	(typ.)	$\Delta\lambda$	34	nm
Half angle	(typ.)	$\varphi$	$\pm 60$	°
Rise and fall time of $I_e$ (10% and 90% of $I_{e\text{max}}$ ) ( $I_F = 100\text{ mA}$ , $t_p = 16\text{ }\mu\text{s}$ , $R_L = 50\text{ }\Omega$ )	(typ.)	$t_r$ , $t_f$	32	ns
Forward voltage ( $I_F = 20\text{ mA}$ )	(typ. (max.))	$V_F$	3.4 ( $\leq 4.4$ )	V
Reverse current		$I_R$	not designed for reverse operation	$\mu\text{A}$
Radiant intensity ( $I_F = 20\text{ mA}$ , $t_p = 20\text{ ms}$ )	(typ.)	$I_e$	1.3	mW / sr
Total radiant flux ( $I_F = 20\text{ mA}$ , $t_p = 20\text{ ms}$ )	(typ.)	$\Phi_e$	2.9	mW
Temperature coefficient of $\lambda_{\text{centroid}}$ ( $I_F = 20\text{ mA}$ , $-10\text{ °C} \leq T \leq 100\text{ °C}$ )	(typ.)	$TC_{\lambda_{\text{centroid}}}$	0.03	nm / K
Temperature coefficient of $V_F$ ( $I_F = 20\text{ mA}$ , $-10\text{ °C} \leq T \leq 100\text{ °C}$ )	(typ.)	$TC_V$	-3.60	mV / K

**Characteristics** ( $T_A = 25\text{ °C}$ )

Parameter		Symbol	Value	Unit
<b>Detector</b>				
Photocurrent ( $E_e = 0.1\text{ mW/cm}^2$ , $\lambda = 530\text{ nm}$ , $V_R = 5\text{ V}$ )	(typ.)	$I_{P,530}$	0.42	$\mu\text{A}$
Photocurrent ( $E_e = 0.1\text{ mW/cm}^2$ , $\lambda = 655\text{ nm}$ , $V_R = 5\text{ V}$ )	(typ.)	$I_{P,655}$	0.76	$\mu\text{A}$
Photocurrent ( $E_e = 0.1\text{ mW/cm}^2$ , $\lambda = 940\text{ nm}$ , $V_R = 5\text{ V}$ )	(typ.)	$I_{P,940}$	1.3	$\mu\text{A}$
Wavelength of max. sensitivity	(typ.)	$\lambda_{S\text{ max}}$	920	nm
Spectral range of sensitivity	(typ.)	$\lambda_{10\%}$	400 ... 1100	nm
Radiation sensitive area	(typ.)	A	1.7	$\text{mm}^2$
Dimensions of radiant sensitive area	(typ.)	L x W	1.3 x 1.3	mm x mm
Dark current ( $V_R = 5\text{ V}$ , $E_e = 0\text{ mW/cm}^2$ )	(typ. (max.))	$I_R$	1 ( $\leq 5$ )	nA
Spectral sensitivity of the chip ( $\lambda = 530\text{ nm}$ )	(typ.)	$S_{\lambda,530}$	0.26	A / W
Spectral sensitivity of the chip ( $\lambda = 655\text{ nm}$ )	(typ.)	$S_{\lambda,655}$	0.47	A / W
Spectral sensitivity of the chip ( $\lambda = 940\text{ nm}$ )	(typ.)	$S_{\lambda,940}$	0.77	A / W
Open-circuit voltage ( $E_e = 0.1\text{ mW/cm}^2$ , $\lambda = 530\text{ nm}$ )	(typ.)	$V_{O,530}$	240	mV
Short-circuit current ( $E_e = 0.1\text{ mW/cm}^2$ , $\lambda = 530\text{ nm}$ )	(typ.)	$I_{SC,530}$	0.40	$\mu\text{A}$
Open-circuit voltage ( $E_e = 0.1\text{ mW/cm}^2$ , $\lambda = 655\text{ nm}$ )	(typ.)	$V_{O,655}$	250	mV
Short-circuit current ( $E_e = 0.1\text{ mW/cm}^2$ , $\lambda = 655\text{ nm}$ )	(typ.)	$I_{SC,655}$	0.71	$\mu\text{A}$
Open-circuit voltage ( $E_e = 0.1\text{ mW/cm}^2$ , $\lambda = 940\text{ nm}$ )	(typ.)	$V_{O,940}$	270	mV
Short-circuit current ( $E_e = 0.1\text{ mW/cm}^2$ , $\lambda = 940\text{ nm}$ )	(typ.)	$I_{SC,940}$	1.2	$\mu\text{A}$

**Characteristics** ( $T_A = 25\text{ °C}$ )

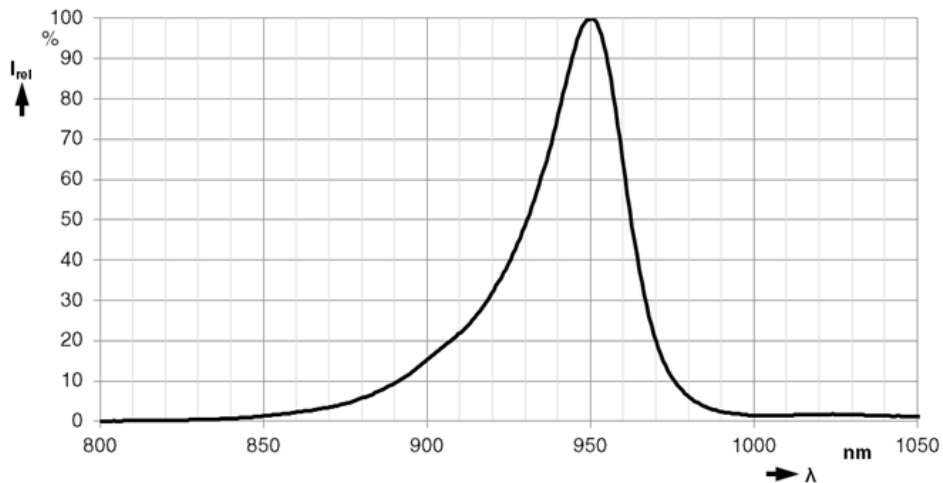
Parameter		Symbol	Value	Unit
Rise and fall time ( $V_R = 3.3\text{ V}$ , $R_L = 50\ \Omega$ , $\lambda = 940\text{ nm}$ )	(typ.)	$t_r$ , $t_f$	2.3	$\mu\text{s}$
Forward voltage ( $I_F = 10\text{ mA}$ , $E = 0\text{ mW/cm}^2$ )	(typ.)	$V_F$	0.9	V
Capacitance ( $V_R = 5\text{ V}$ , $f = 1\text{ MHz}$ , $E = 0\text{ mW/cm}^2$ )	(typ.)	$C_0$	5	pF



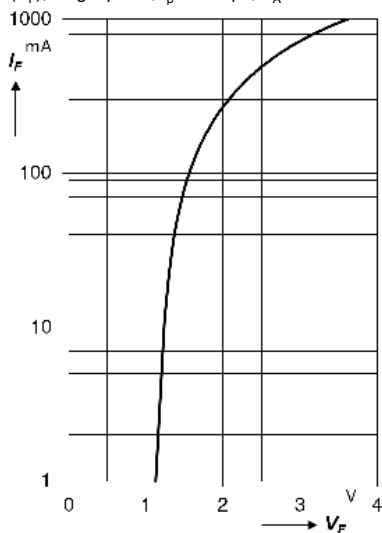
## Diagrams for infrared emitter

Relative spectral emission <sup>1)</sup>

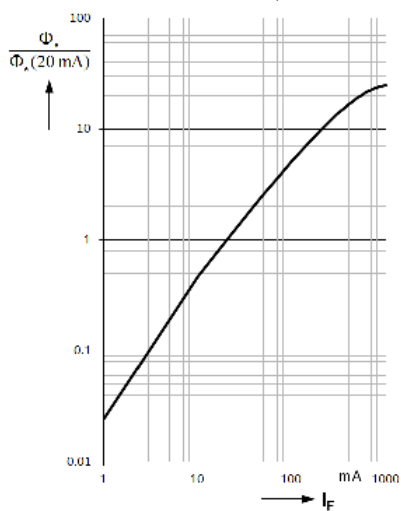
$$I_{\text{rel}} = f(\lambda), T_A = 25^\circ\text{C}, I_F = 20\text{ mA}$$

Forward current <sup>1)</sup>

$$I_F = f(V_F), \text{ single pulse, } t_p = 100\ \mu\text{s}, T_A = 25^\circ\text{C}$$

Relative radiant flux <sup>1)</sup>

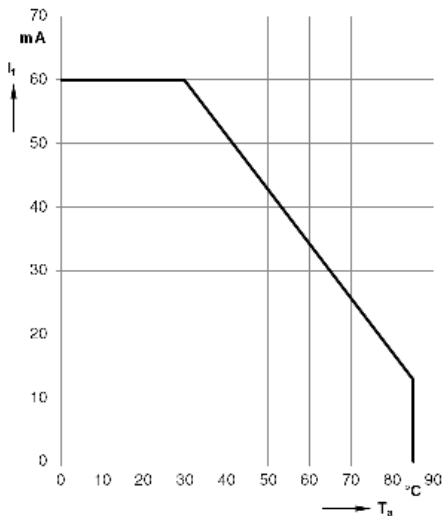
$$\Phi_e / \Phi_e(20\text{ mA}) = f(I_F), \text{ single pulse, } t_p = 25\ \mu\text{s}, T_A = 25^\circ\text{C}$$



Diagrams for infrared emitter

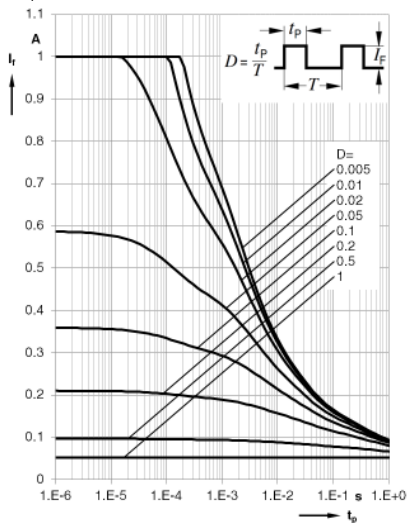
Max. permissible forward current <sup>1)</sup>

$$I_{F,max} = f(T_A), R_{thJA} = 800 \text{ K/W}$$



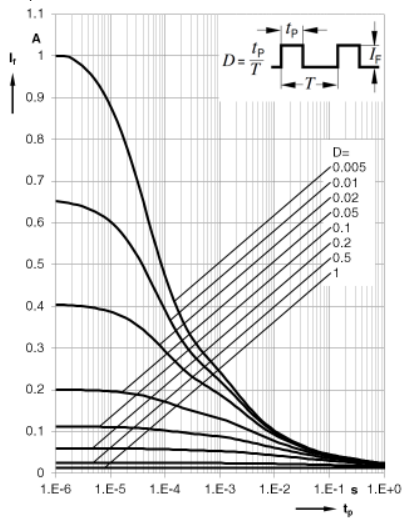
Permissible pulse handling capability <sup>1)</sup>

$$I_F = f(t_p), T_A = 40^\circ\text{C}, \text{ duty cycle } D = \text{parameter}$$



Permissible pulse handling capability <sup>1)</sup>

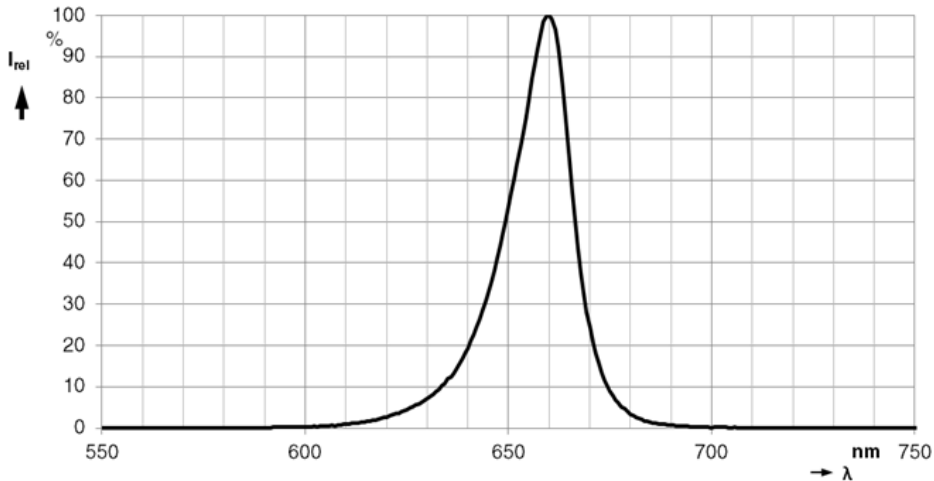
$$I_F = f(t_p), T_A = 85^\circ\text{C}, \text{ duty cycle } D = \text{parameter}$$



Diagrams for red emitter

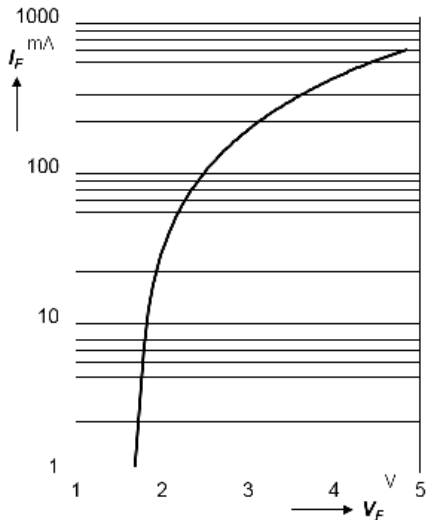
Relative spectral emission <sup>1)</sup>

$I_{rel} = f(\lambda)$ ,  $T_A = 25^\circ\text{C}$ ,  $I_F = 20\text{ mA}$



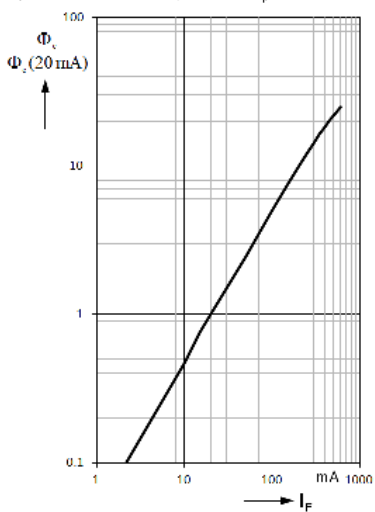
Forward current <sup>1)</sup>

$I_F = f(V_F)$ ,  $T_A = 25^\circ\text{C}$



Relative radiant flux <sup>1)</sup>

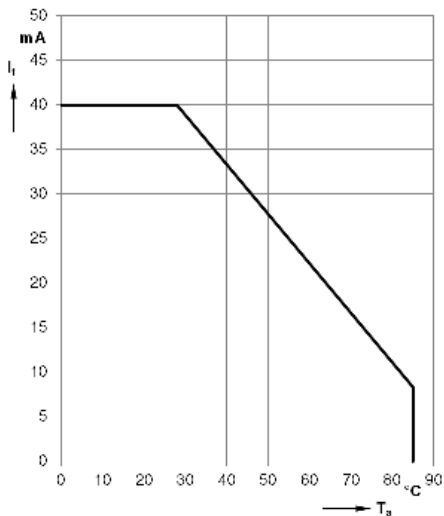
$\Phi_e / \Phi_e(20\text{ mA}) = f(I_F)$ , single pulse,  $t_0 = 25\mu\text{s}$ ,  $T_A = 25^\circ\text{C}$



Diagrams for red emitter

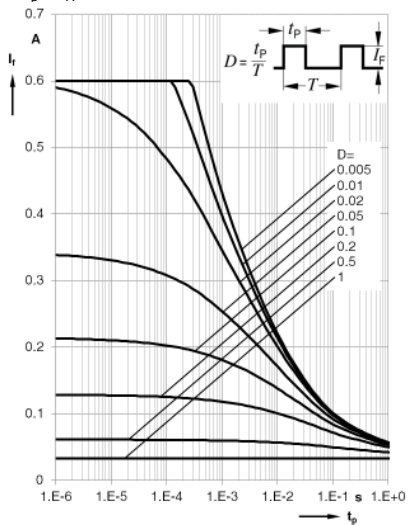
Max. permissible forward current <sup>1)</sup>

$I_{F,max} = f(T_A), R_{thJA} = 800 \text{ K/W}$



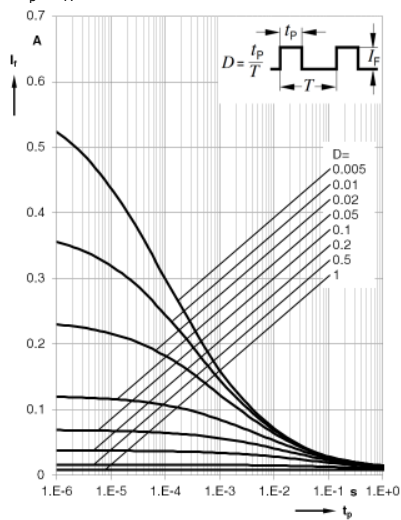
Permissible pulse handling capability <sup>1)</sup>

$I_F = f(t_p), T_A = 40^\circ\text{C}, \text{duty cycle } D = \text{parameter}$



Permissible pulse handling capability <sup>1)</sup>

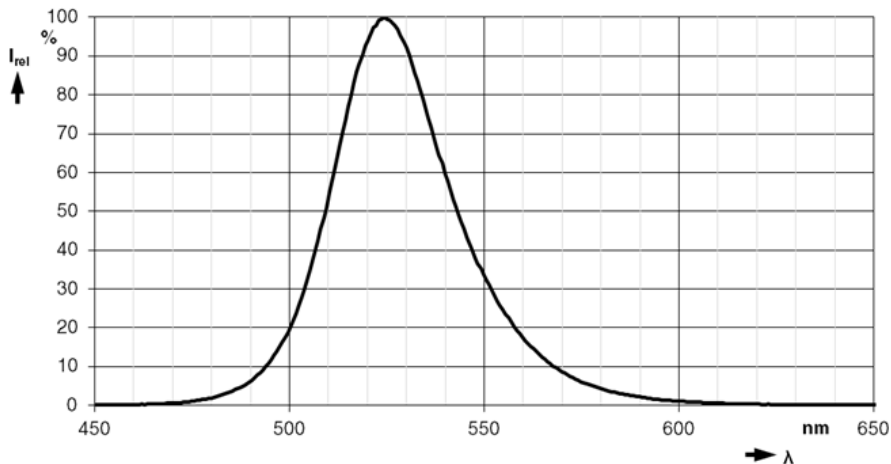
$I_F = f(t_p), T_A = 85^\circ\text{C}, \text{duty cycle } D = \text{parameter}$



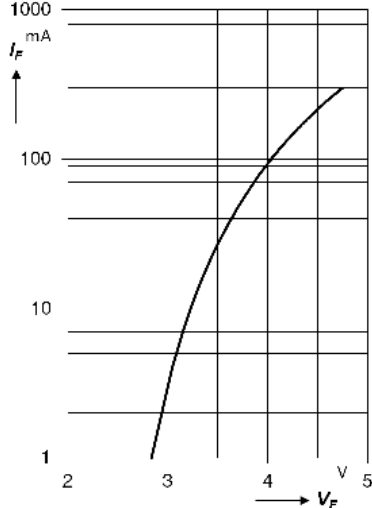
## Diagrams for green emitter

Relative spectral emission <sup>1)</sup>

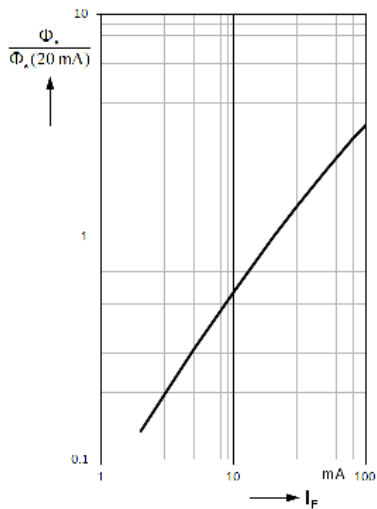
$$I_{\text{rel}} = f(\lambda), T_A = 25^\circ\text{C}, I_F = 20\text{ mA}$$

Forward current <sup>1)</sup>

$$I_F = f(V_F), T_A = 25^\circ\text{C}$$

Relative radiant flux <sup>1)</sup>

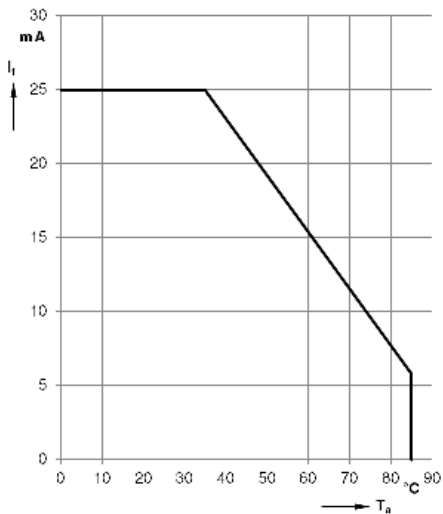
$$\Phi_e / \Phi_e(20\text{ mA}) = f(I_F), \text{ single pulse, } t_0 = 25\mu\text{s}, T_A = 25^\circ\text{C}$$



Diagrams for green emitter

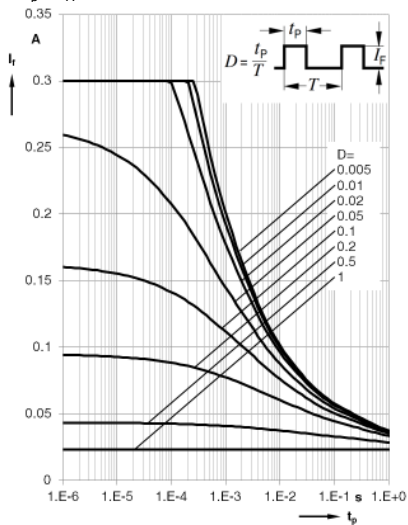
Max. permissible forward current <sup>1)</sup>

$I_{F,max} = f(T_A), R_{thJA} = 800 \text{ K/W}$



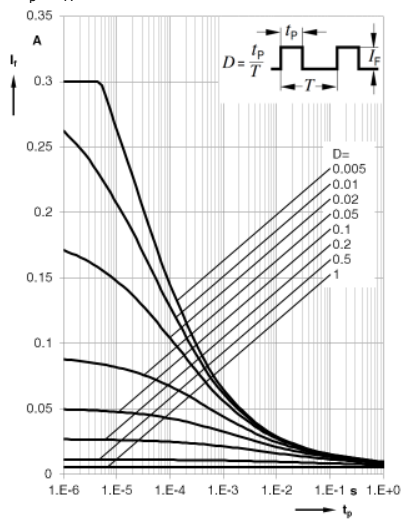
Permissible pulse handling capability <sup>1)</sup>

$I_F = f(t_p), T_A = 40^\circ\text{C}, \text{ duty cycle } D = \text{parameter}$



Permissible pulse handling capability <sup>1)</sup>

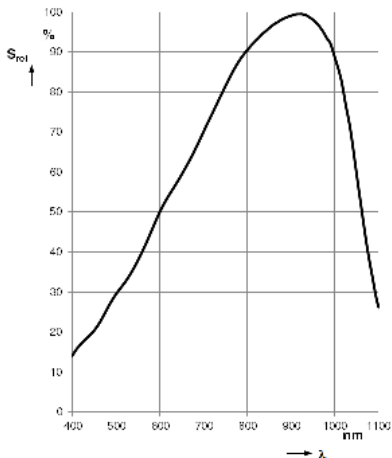
$I_F = f(t_p), T_A = 85^\circ\text{C}, \text{ duty cycle } D = \text{parameter}$



**Diagrams for detector**

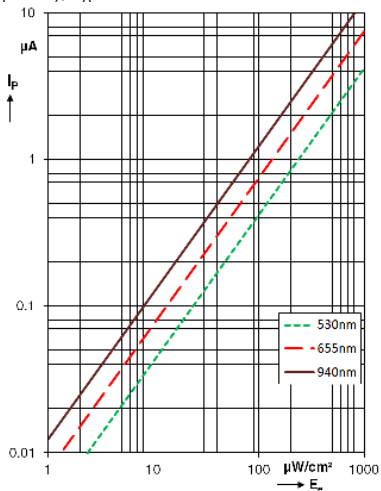
**Relative spectral sensitivity <sup>1)</sup>**

$S_{rel} = f(\lambda), T_A = 25\text{ }^\circ\text{C}$



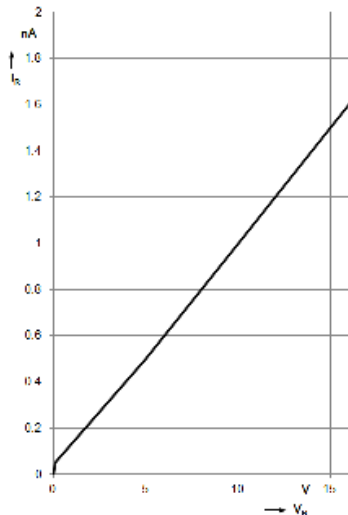
**Photocurrent <sup>1)</sup>**

$I_P(V_R = 5\text{ V}), T_A = 25\text{ }^\circ\text{C}$



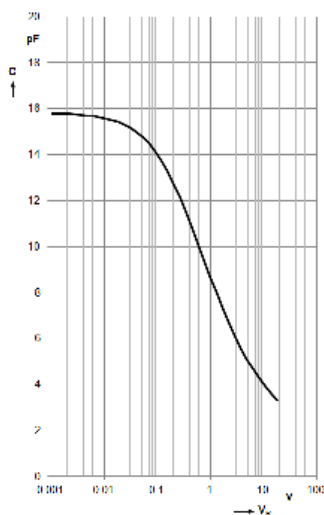
**Dark current <sup>1)</sup>**

$I_R = f(V_R), E = 0\text{ mW/cm}^2, T_A = 25\text{ }^\circ\text{C}$



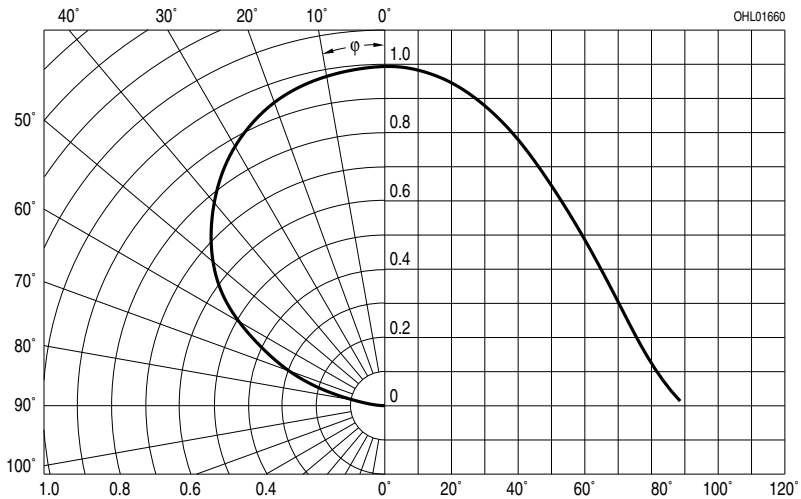
**Capacitance <sup>1)</sup>**

$C = f(V_R), f = 1\text{ MHz}, E = 0\text{ mW/cm}^2, T_A = 25\text{ }^\circ\text{C}$



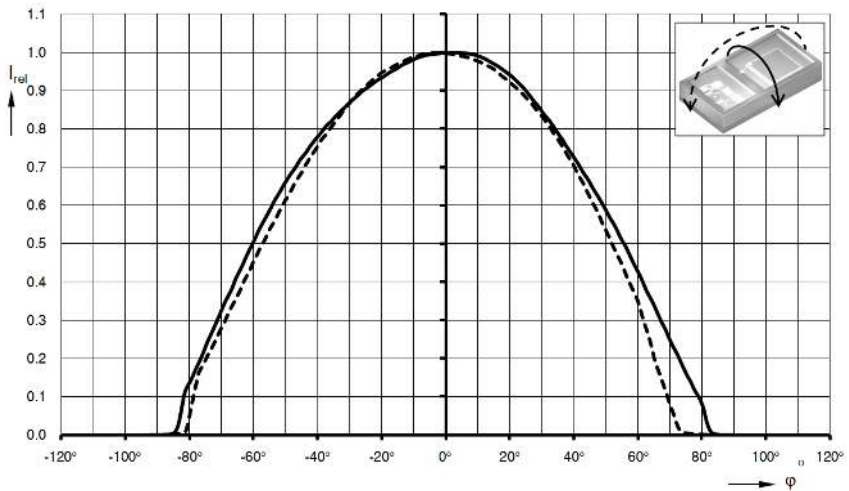
**Directional characteristics of detector <sup>1)</sup>**

$S_{rel} = f(\varphi)$



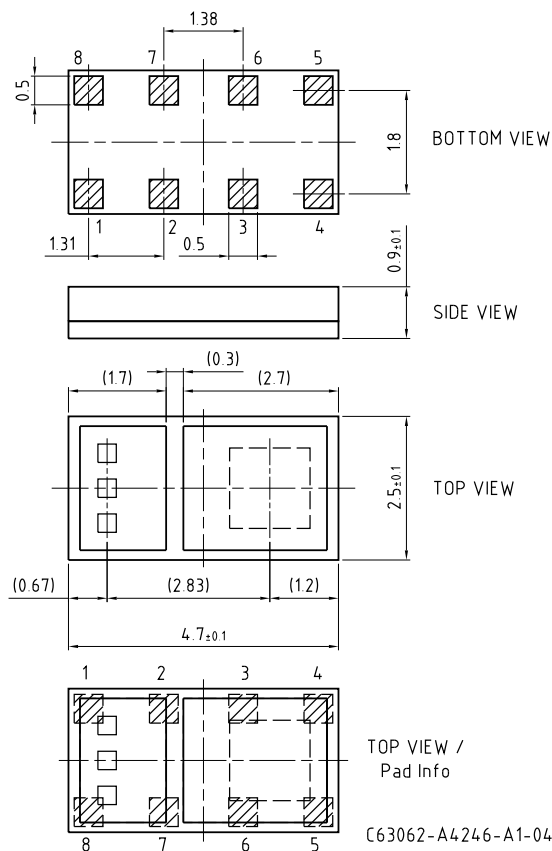
**Radiation characteristics of emitters <sup>1)</sup>**

$I_{rel} = f(\varphi)$





## Package Outline



Pin1	Green LED cathode
Pin2	Green LED anode
Pin3	Red LED anode
Pin4	PD anode
Pin5	PD cathode
Pin6	Red LED cathode
Pin7	IR LED anode
Pin8	IR LED cathode

Dimensions in mm.

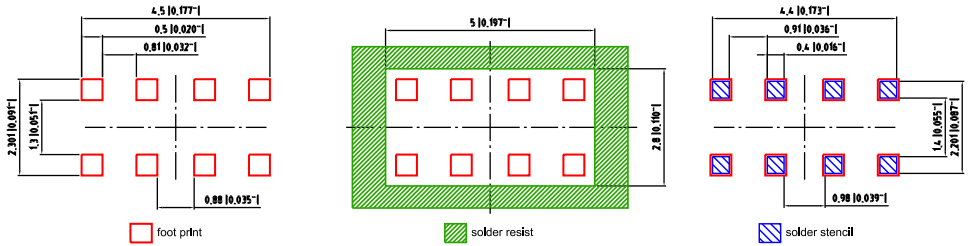
**Package:**

chip on board

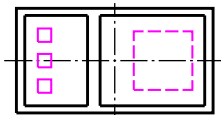
**Approximate Weight:**

18 mg

**Recommended solder pad design**



**Component Location on Pad**

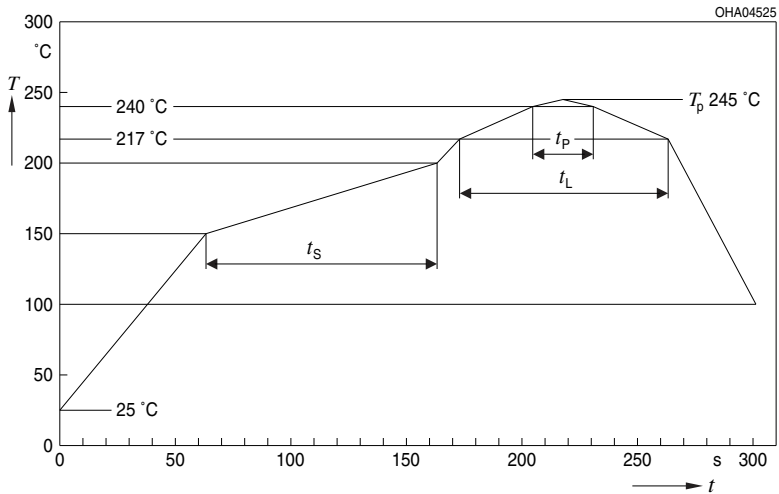


Dimensions in mm (inch).

E062 3010 172-01

**Reflow Soldering Profile**

Product complies to MSL Level 4 acc. to JEDEC J-STD-020D.01



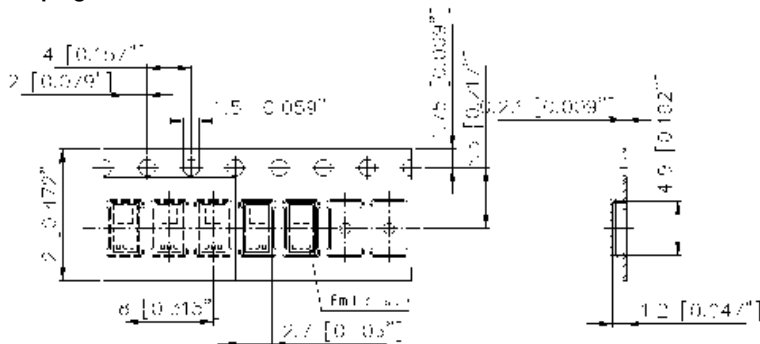
OHA04612

Profile Feature Profil-Charakteristik	Symbol Symbol	Pb-Free (SnAgCu) Assembly			Unit Einheit
		Minimum	Recommendation	Maximum	
Ramp-up rate to preheat*) 25 °C to 150 °C			2	3	K/s
Time $t_s$ $T_{Smin}$ to $T_{Smax}$	$t_s$	60	100	120	s
Ramp-up rate to peak*) $T_{Smax}$ to $T_p$			2	3	K/s
Liquidus temperature	$T_L$	217			°C
Time above liquidus temperature	$t_L$		80	100	s
Peak temperature	$T_p$		245	260	°C
Time within 5 °C of the specified peak temperature $T_p$ - 5 K	$t_p$	10	20	30	s
Ramp-down rate* $T_p$ to 100 °C			3	6	K/s
Time 25 °C to $T_p$				480	s

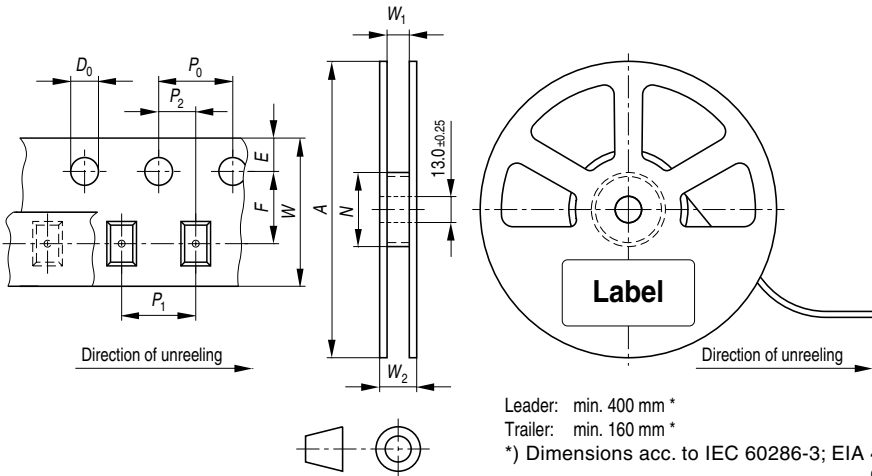
All temperatures refer to the center of the package, measured on the top of the component

\* slope calculation  $DT/Dt$ :  $Dt$  max. 5 s; fulfillment for the whole T-range

## Method of Taping



Dimensions in mm [inch].

**Tape and Reel**12 mm tape with 3000 pcs. on  $\varnothing$  180 mm reel

Dimensions in mm

**Tape Dimensions [mm]**

W	P <sub>0</sub>	P <sub>1</sub>	P <sub>2</sub>	D <sub>0</sub>	E	F
12 +0.3 / -0.1	4 ±0.1	4 ±0.1	2 ±0.05	1.5 ±0.1	1.75 ±0.1	5.5 ±0.05

**Reel Dimensions [mm]**

A	W	N <sub>min</sub>	W <sub>1</sub>	W <sub>2max</sub>
180	12	60	12.4 +2	18.4

## Barcode-Product-Label (BPL)

**OSRAM Opto Semiconductors** LX XXXX BIN1: XX-XX-X-XXX-X

RoHS Compliant


(6P) BATCH NO: 1234567890

(1T) LOT NO: 1234567890 (9D) D/C: 1234

(X) PROD NO: 123456789 (Q) QTY: 9999 (G) GROUP: XX-XX-X-X

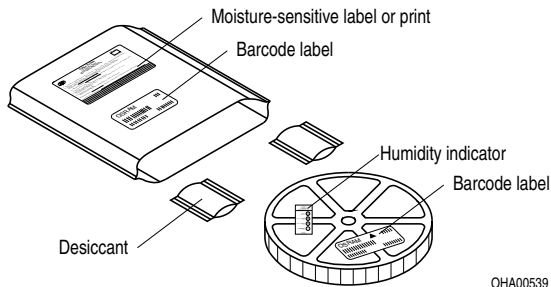
ML Temp ST  
X XXX °C X

Pack: RXX  
DEMY XXX  
X\_X123\_1234.1234 X



OHA04563

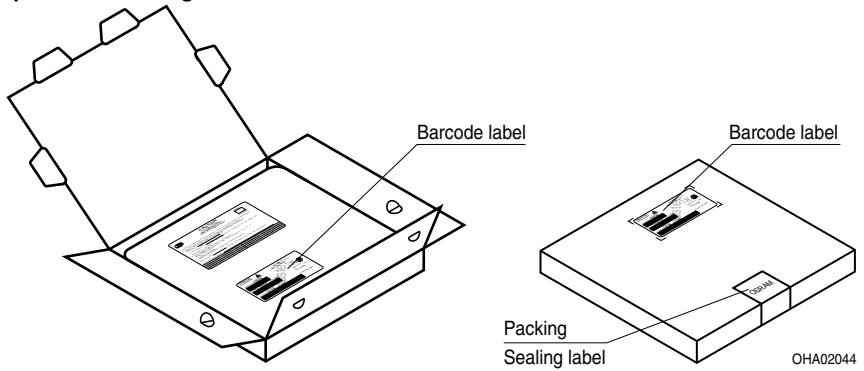
## Dry Packing Process and Materials



## Note:

Moisture-sensitive product is packed in a dry bag containing desiccant and a humidity card. Regarding dry pack you will find further information in the internet. Here you will also find the normative references like JEDEC.

### Transportation Packing and Materials



### Dimensions of transportation box in mm

Width	Length	Height
195 ± 5	195 ± 5	42 ± 5

## Disclaimer

Language english will prevail in case of any discrepancies or deviations between the two language wordings.

### Attention please!

The information describes the type of component and shall not be considered as assured characteristics.

Terms of delivery and rights to change design reserved. Due to technical requirements components may contain dangerous substances.

For information on the types in question please contact our Sales Organization. If printed or downloaded, please find the latest version in the Internet.

### Packing

Please use the recycling operators known to you. We can also help you – get in touch with your nearest sales office. By agreement we will take packing material back, if it is sorted. You must bear the costs of transport. For packing material that is returned to us unsorted or which we are not obliged to accept, we shall have to invoice you for any costs incurred.

### Components used in life-support devices or systems must be expressly authorized for such purpose!

Critical components\* may only be used in life-support devices\*\* or systems with the express written approval of OSRAM OS.

\*) A critical component is a component used in a life-support device or system whose failure can reasonably be expected to cause the failure of that life-support device or system, or to affect its safety or the effectiveness of that device or system.

\*\*) Life support devices or systems are intended (a) to be implanted in the human body, or (b) to support and/or maintain and sustain human life. If they fail, it is reasonable to assume that the health and the life of the user may be endangered.

## Glossary

- 1) **Typical Values:** Due to the special conditions of the manufacturing processes of LED and photodiodes, the typical data or calculated correlations of technical parameters can only reflect statistical figures. These do not necessarily correspond to the actual parameters of each single product, which could differ from the typical data and calculated correlations or the typical characteristic line. If requested, e.g. because of technical improvements, these typ. data will be changed without any further notice.

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EU RoHS and China RoHS compliant product



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按照中国的相关法规和标准，不含有毒有害物质或元素。